

SMT Pick and Place Nozzle QP3

This QP3 nozzle is designed for use in FUJI SMT pick and place machines. It facilitates the accurate and reliable placement of components onto PCBs during the SMT assembly process.



Product Overview

High-Precision SMT Nozzle

This high-precision QP3 nozzle is expertly engineered for consistent and reliable component placement in PCB assembly environments. Designed for compatibility with high-speed machinery, it provides stable vacuum pressure to ensure secure component handling. Its robust construction minimizes loss rates and maximizes overall pick-and-place efficiency, making it an essential component for high-quality production lines.

Compatibility and Design

Compatibility	FUJI SMT
Model Identifier	QP3

Performance Features

Core Advantages

- Optimized vacuum pressure
- High-speed production durability
- High-precision alignment
- Reliable component grip